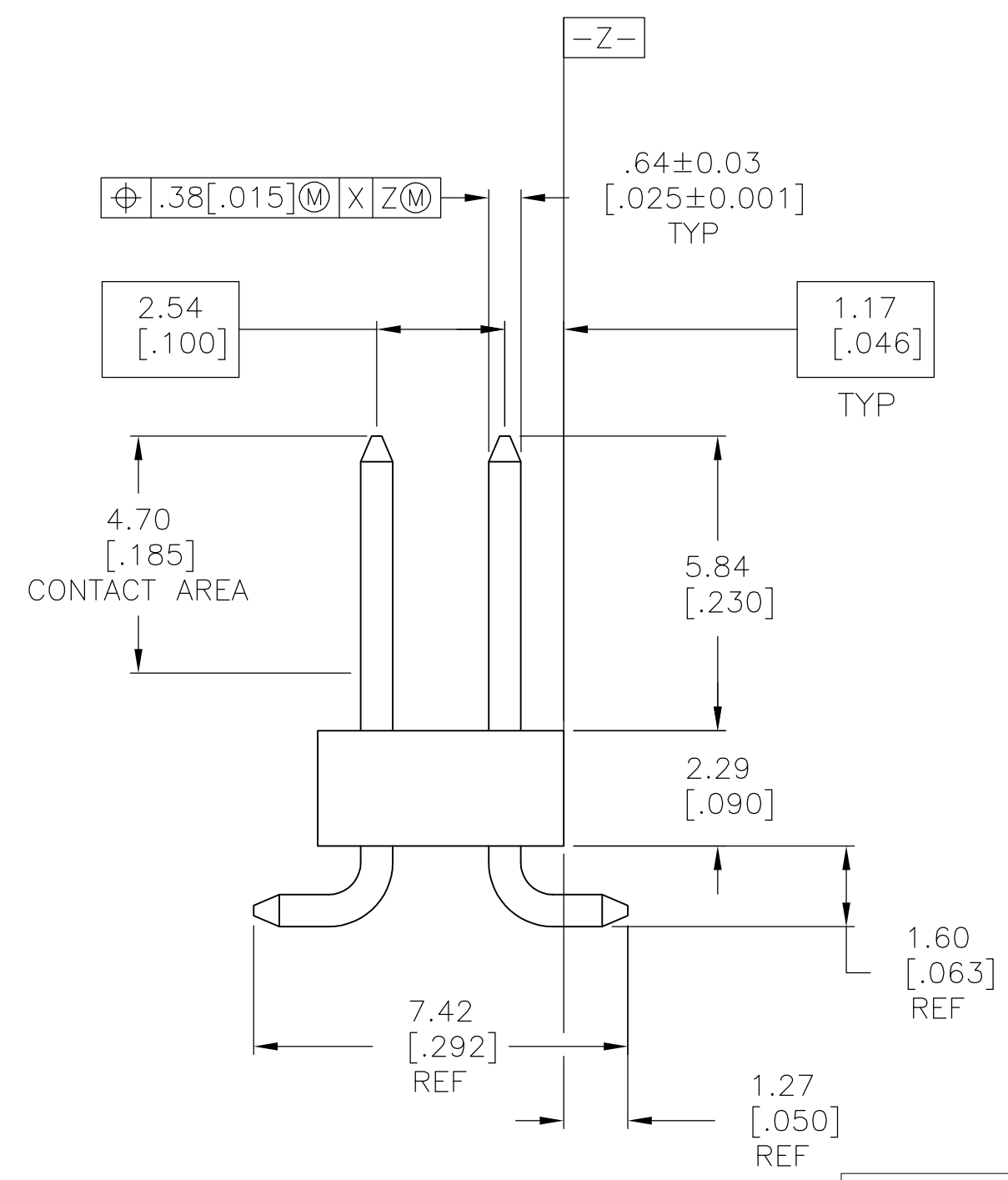




RECOMMENDED PCB LAYOUT
FOR USE WITH .008 THICK STENCIL

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN J KNAUB	30SEP94	 TE Connectivity
DIMENSIONS: mm [INCHES]	TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 P/LC ± 1 P/LC ± 2 P/LC ± 0.13[.005] 3 P/LC ± 4 P/LC ± ANGLES ± °	CHK G DUBNICZKI	30SEP94	
		APVD G DUBNICZKI	30SEP94	
		PRODUCT SPEC		SURFACE MOUNT HEADER ASSEMBLY, MOD II, BREAKAWAY, VERTICAL, DOUBLE ROW, .100 X.100 CL, .025 SQ. POST
MATERIAL		APPLICATION SPEC		
FINISH		WEIGHT		
	SEE TABLE	SIZE		CASE CODE DRAWING NO A1 00779 © 146134
		RESTRICTED TO		
		CUSTOMER DRAWING		SCALE 8:1
				SHEET 1 OF 1
				REV N5

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